



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : **Confirmation No. 4502**
Norihito TSUKAHARA et al. : Docket No. 2003-1827
Serial No. 10/736,568 : Group Art Unit 2825
Filed December 17, 2003 :

SEMICONDUCTOR DEVICE PACKAGE
MANUFACTURING METHOD AND
SEMICONDUCTOR DEVICE PACKAGE
MANUFACTURED BY THE METHOD

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Prior to examination of the above-referenced U.S. patent application please amend the application as follows: